

N-channel 100V 5 m $\Omega$  standard level MOSFET in TO220F (SOT186A)

Rev. 1 — 3 July 2012

**Product data sheet** 

#### **Product profile** 1.

#### **1.1 General description**

Standard level N-channel MOSFET in TO220F (SOT186A) package qualified to 175C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

#### 1.2 Features and benefits

High efficiency due to low switching and conduction losses

#### 1.3 Applications

- AC-to-DC power supply equipment
- Motor control

1.4 Quick reference data

- Isolated package Suitable for standard level gate drive
- Server power supplies
- Synchronous rectification

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	-	100	V
I <sub>D</sub>	drain current	$T_{mb}$ = 25 °C; $V_{GS}$ = 10 V; see <u>Figure 1</u>	-	-	67.5	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	63.8	W
Static cha	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	4.2	5	mΩ
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	$V_{GS}$ = 10 V; $I_{D}$ = 15 A; $V_{DS}$ = 50 V;	-	40	-	nC
Q <sub>G(tot)</sub>	total gate charge	see Figure 14; see Figure 15	-	153	-	nC
	e ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \; V; \; T_{j(\text{init})} = 25 \; ^{\circ}\text{C}; \; I_{D} = 67.5 \; A; \\ V_{sup} \leq 100 \; V; \; unclamped; \; R_{GS} = 50 \; \Omega; \\ see \; \underline{Figure 3} \end{array}$	-	-	700	mJ



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### 2. Pinning information

Table 2.	Pinning	g information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	D D
3	S	source		
mb		mounting base; isolated		mbb076 S

SOT186A (TO-220F)

### 3. Ordering information

#### Table 3.Ordering information

Type number	Package		
	Name	Description	Version
PSMN5R0-100XS	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"	SOT186A

### 4. Marking

Table 4. Marking codes	
Type number	Marking code
PSMN5R0-100XS	PSMN5R0-100XS

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### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	100	V
V <sub>DGR</sub>	drain-gate voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C; R <sub>GS</sub> = 20 kΩ	-	100	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$V_{GS} = 10 \text{ V}; \text{ T}_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{10000000000000000000000000000000000$	-	67.5	А
		$V_{GS} = 10 \text{ V}; \text{ T}_{mb} = 100 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{100 \text{ Figure 1}}$	-	47.7	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 4	-	270	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	63.8	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature		-	260	°C
Source-dra	in diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	53.2	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$	-	270	А
Avalanche	ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 67.5 A; $V_{sup}$ ≤ 100 V; unclamped; $R_{GS}$ = 50 Ω; see Figure 3	-	700	mJ

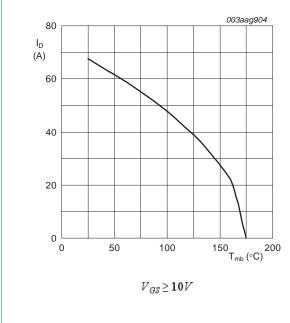
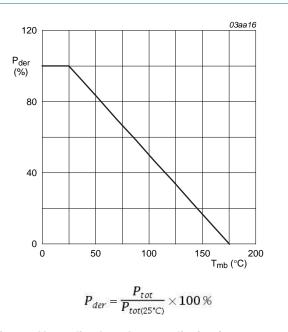


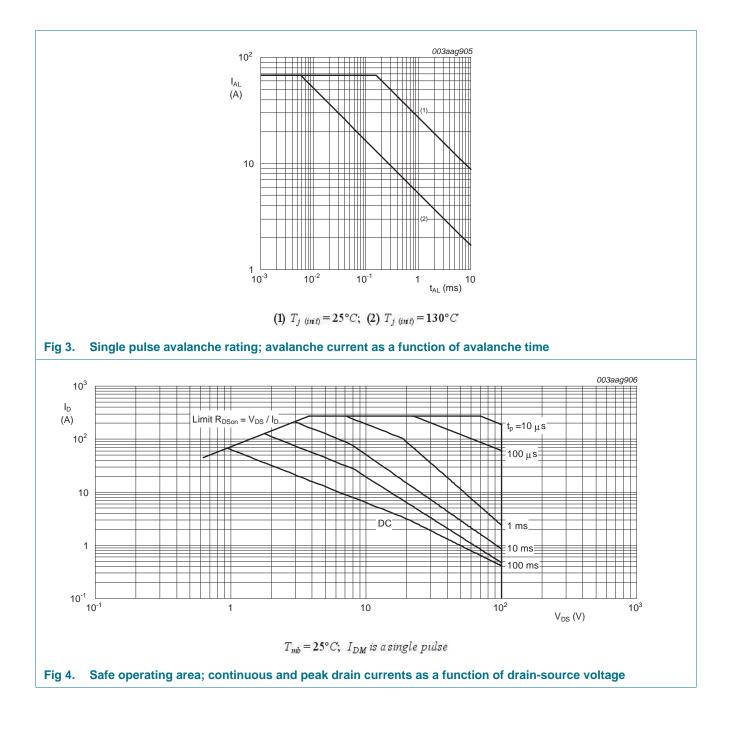
Fig 1. Continuous drain current as a function of mounting base temperature





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### 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see Figure 5	-	2.1	2.35	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	vertical in free air	-	55	-	K/W

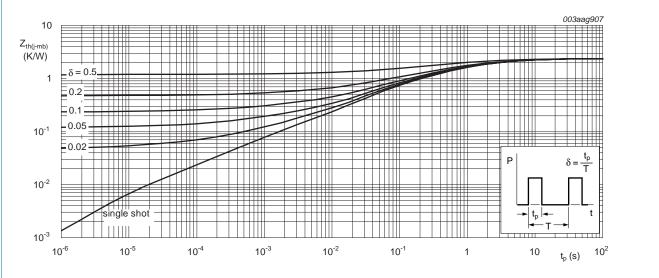


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

### 7. Isolation characteristics

#### Table 7. Isolation characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C <sub>isol</sub>	isolation capacitance		<u>[1]</u>	-	10	-	pF
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; sinusoidal waveform; clean and dust free		-	-	2500	V

[1] f = 1 MHz

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### 8. Characteristics

Table 8.	Characteristics Parameter	Conditions	Min	Turn	Max	Unit
Symbol Static char		Conditions	11111	Тур	wax	Unit
	droip course breekdown		100			V
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = 25 \ ^{\circ}C$	100	-		-
. ,	-	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = -55 \ ^{\circ}C$	90	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>	2	3	4	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 10</u>	1	-	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = -55 °C; see <u>Figure 10</u>	-	-	4.6	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 100 °C	-	-	200	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
	-	V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	2	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 25 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	4.2	5	mΩ
		$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 100 °C; see <u>Figure 13</u>	-	7.35	8.8	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 175 °C; see <u>Figure 13</u>	-	11.8	14	mΩ
R <sub>G</sub>	internal gate resistance (AC)	f = 1 MHz	-	0.9	-	Ω
Dynamic c	haracteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	-	153	-	nC
Q <sub>GS</sub>	gate-source charge	see Figure 14; see Figure 15	-	28	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge		-	25	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge		-	3	-	nC
Q <sub>GD</sub>	gate-drain charge		-	40	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15};$	-	3.5	-	V
C <sub>iss</sub>	input capacitance	$V_{DS} = 50 \text{ V}; \text{ V}_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$ T <sub>j</sub> = 25 °C; see Figure 16; see Figure 17	-	9900	-	pF
C <sub>oss</sub>	output capacitance	V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 0 V; f = 1 MHz; T <sub>j</sub> = 25 °C; see <u>Figure 16</u>	-	660	-	pF
C <sub>rss</sub>	reverse transfer capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ T <sub>j</sub> = 25 °C; see Figure 16; see Figure 17	-	381	-	pF
td(on)	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 4 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	35	-	ns
r	rise time	$R_{G(ext)} = 4.7 \ \Omega; \ T_{j} = 25 \ ^{\circ}C$	-	40	-	ns
d(off)	turn-off delay time		-	170	-	ns
t <sub>f</sub>	fall time		-	71	-	ns

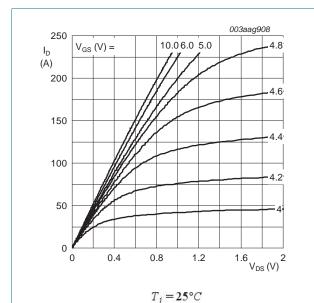
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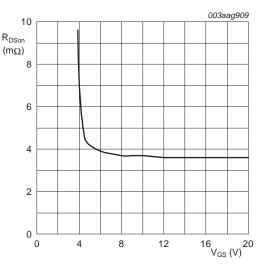
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#### Table 8. Characteristics ...continued

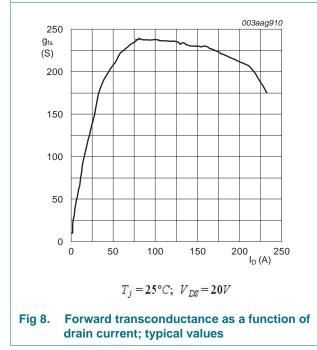
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dra	ain diode					
$V_{SD}$	source-drain voltage	I <sub>S</sub> = 10 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 18</u>	-	0.72	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_{S} = 10 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s};$	-	63	-	ns
Qr	recovered charge	$V_{GS} = 0 V; V_{DS} = 50 V$	-	173	-	nC



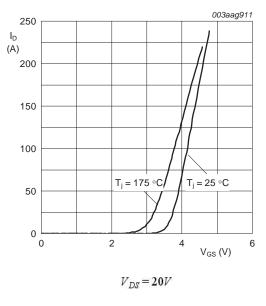








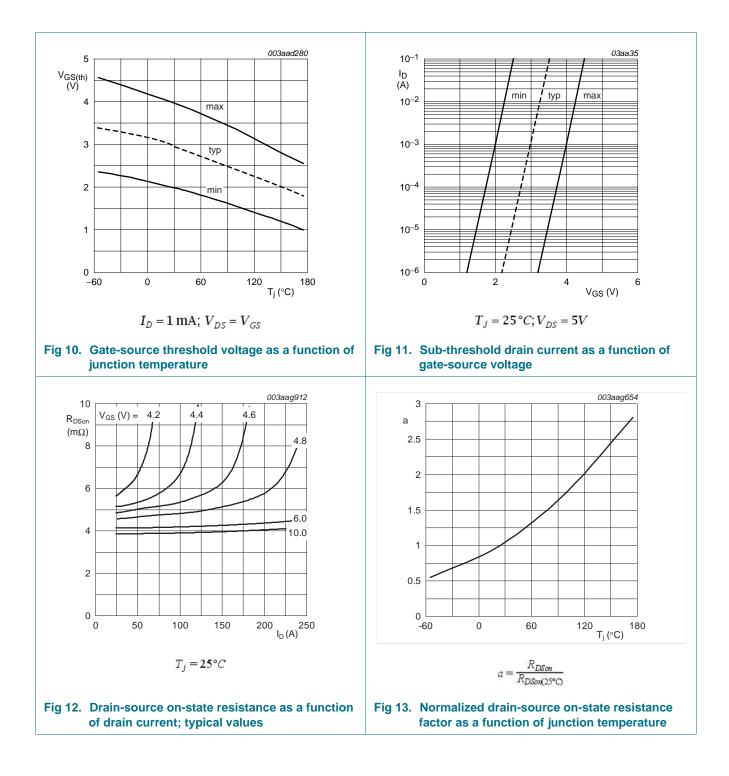




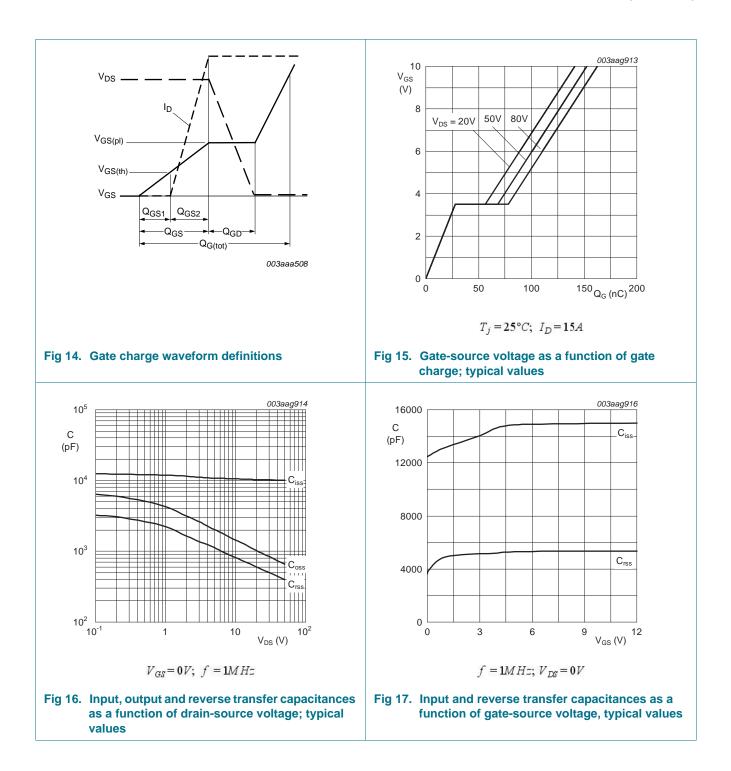


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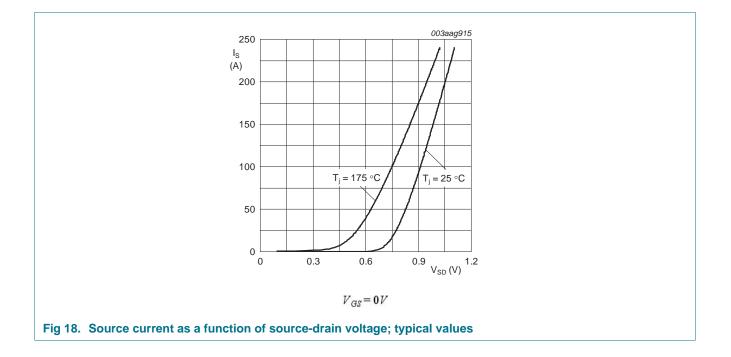


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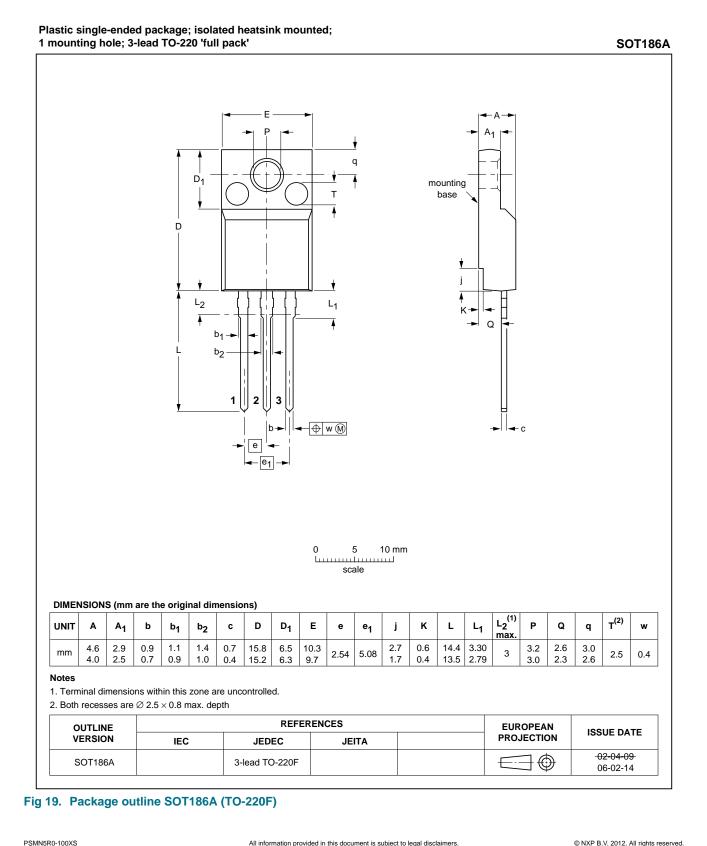
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#### **Package outline** 9.



**Product data sheet** 

### N-channel 100V 5 mΩ standard level MOSFET in TO220F (SOT186A)

### **10. Revision history**

Table 9. Revision h	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PSMN5R0-100XS v.1	20120703	Product data sheet	-	-		

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#### 11.1 Data sheet status

Document status[1] [2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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